

H1 NY PMS 440 0025 PH H2 NY PMS 440 0025 PH H3 NY PMS 440 0025 PH H4 NY PMS 440 0025 PH

H5 1902C H6 1902C H7 1902C H8 1902C



FID1 FID2 FID3 FID4 FID5 FID6

PCB Number: PRJ_Number
PCB Rev: PCB_Rev
PCB LOGO
Texas Instruments
PCB LOGO
Pb-Free Symbol

H69 R1/4-20X3/8 2701 H70 R1/4-20X3/8 2701
H71 1/4-20 AJ 6 H72 1/4-20 AJ 6
H73 F1283 H74 F1283
H75 HN55 102 H76 HN55 102

Label Table

Variant	Label Text
001	SM72295 REVC
002	ChangeMe!

LBL1
PCB Label
Size: 0.65" x 0.20"

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ5
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ6
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ7
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ8
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

H64
HS-5.4-5.4-1.4-01

H9 RM3X12MM 2701 H10 RM3X12MM 2701 H11 RM3X12MM 2701 H12 RM3X12MM 2701 H13 RM3X12MM 2701 H14 RM3X12MM 2701 H15 RM3X12MM 2701 H16 RM3X12MM 2701 H17 RM3X12MM 2701 H18 RM3X12MM 2701

H19 RM3X12MM 2701 H20 RM3X12MM 2701 H21 RM3X12MM 2701 H22 RM3X12MM 2701 H23 RM3X12MM 2701 H24 RM3X12MM 2701 H25 RM3X12MM 2701 H26 RM3X12MM 2701 H27 RM3X12MM 2701 H28 RM3X12MM 2701

H65 RM3X12MM 2701 H66 RM3X12MM 2701 H67 RM3X12MM 2701 H68 RM3X12MM 2701 H50 NONE H51 NONE

H29 [MECH] ATS-PPS-06 H30 [MECH] ATS-PPS-06 H31 [MECH] ATS-PPS-06 H32 [MECH] ATS-PPS-06 H33 [MECH] ATS-PPS-06 H34 [MECH] ATS-PPS-06 H35 [MECH] ATS-PPS-06 H36 [MECH] ATS-PPS-06 H37 [MECH] ATS-PPS-06 H38 [MECH] ATS-PPS-06

H40 [MECH] ATS-PPS-06 H41 [MECH] ATS-PPS-06 H42 [MECH] ATS-PPS-06 H43 [MECH] ATS-PPS-06 H44 [MECH] ATS-PPS-06 H45 [MECH] ATS-PPS-06 H46 [MECH] ATS-PPS-06 H47 [MECH] ATS-PPS-06 H48 [MECH] ATS-PPS-06 H49 [MECH] ATS-PPS-06

H39 [MECH] TG6050-150-150-0.5-0 H63 [MECH] HSS-5.4-1.5-AL-01

H60 [MECH] FNLK-120-01

H61 [MECH] WSU120-1000

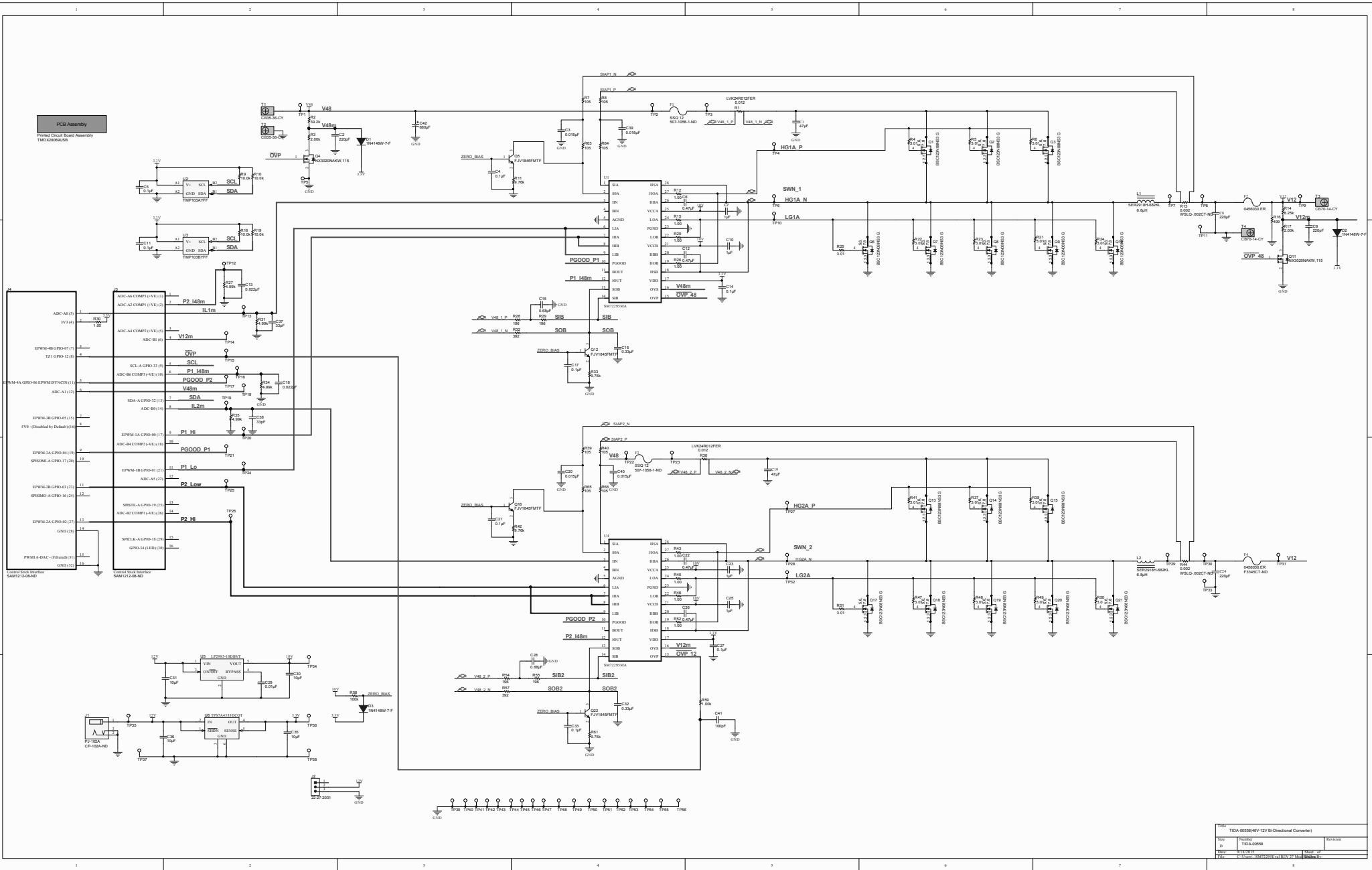
H62 [MECH] DFS123812H-3000

Designed for: PRJ_Customer Mod. Date: 5/12/2015
Project Title: PRJ_Title
Number: PRJ_Number | Rev: SCH_Sch | Sheet: 1 of 1
Assembly Variant: [No Variations]
File: Hardware ANSI-B_SchDoc
Contact: TechSupport



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PCB Assembly
Printed Circuit Board Assembly
TMD02866505



FILE	TIDA-02866505-12V Bi-Directional Converter	
REV	0002	External
BY	TDA-02866505	
APP	110-0010	Rev 00
DATE	07/2011	07/2011

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